02-03-2004



Attorney Docket No. 843.43437X0

Form PTO-1595 RE102659748 (Rev. 10/02) OMB No. 0651-0027 (exp. 6/30/2005)

S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof. 1. Name of conveying party(ies): 2. Name and address of receiving party(ies) Name: TRECENTI TECHNOLOGIES, INC. Address: 751, Horiguchi, Hitachinaka-shi, Ibaraki 312-0034, Japan Additional name(s) of conveying party(ies) attached? \square Yes \boxtimes No ☐ Merger ☐ Change of Name Additional name(s) & address(es) attached? ☐ Yes ☒ No Execution Date: December 4, 2003. 4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: December 4, 2003. A. Patent Application No.(s) B. Patent Registration No.(s) 10764563 Additional number(s) attached Yes No 5. Name and address of party to whom correspondence 6. Total number of applications and patents involved 1 concerning document should be mailed: 7. Total fee (37 CFR 3.41)..... \$40.00 Name: Antonelli, Terry, Stout & Kraus, LLP □ Enclosed Authorized to be charged to deposit account 1300 North Seventeenth Street 8. Deposit account number: 01-2135 City: ____ State: ___ Zip: ____ (Attach duplicate copy of this page if paying by deposit account) DO NOT USE THIS SPACE

9. Statement and signature.

Arlington, VA 22209

Internal Address:

Suite 1800

USA

TOKUNAGA, KENJI

3. Nature of conveyance:

☐ Security Agreement

Assignment Assignment

Other _

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

William I. Solomon, Reg# 28,565

Name of Person Signing

01/27/2004

Date

Total number of pages including cover sheet, attachments, and document: 2 Mail documents to be recorded with required cover sheet information to: Commissioner of Patent & Trademarks, Box Assignments

Washington, D.C. 20231

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ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Trecenti Technologies, Inc., a corporation organized under the laws of Japan, located at 751, Horiguchi, Hitachinaka-shi, Ibaraki 312-0034, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Trecenti Technologies, Inc., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

METHOD OF PURGING WAFER RECEIVING JIG, WAFER TRANSFER DEVICE, AND METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Trecenti Technologies, Inc., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Trecenti Technologies, Inc.,

Signed on the date(s) indicated aside signatures:

INVENTOR(S)

RECORDED: 01/27/2004

(発明者フルネームサイン)			(署名日)	
1) Karji Joku	nega	(Kenji TOKUNAGA)	4/Dec. 12	003
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3)				
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9)				
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PATENT REEL: 014931 FRAME: 0647

Date Signed